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# Air Exposure Improvement of Optical Properties of Hydrogenated Nanostructured Silicon Thin Films for Optoelectronic Application

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## 1. Introduction

Silicon is the desired material, because silicon optoelectronics will open the door to faster data transfer and higher integration densities at very low cost. Silicon microphotronics has boomed these last years. In addition, silicon, the most important elemental semiconductor, crystallizes in the diamond structure. The diamond lattice consists of two interpenetrating face centered cubic Bravais lattices displaced along the body diagonal of the cubic cell by one quarter of the length of the diagonal.

Nowadays, hydrogenated nanostructured silicon with grains in nanometer size has attracted more attention in optoelectronic and microelectronic devices for its superior properties (Kanicki, 1991, 1992; Canham, 1990; Lin et al., 2006, Funde et al., 2008, Cheng et al., 2008). Moreover, great efforts have been devoted to photoluminescence of silicon-based materials for developing integrated optoelectronics with the standard silicon very-large-scale integration technology (Canham, 1990). For example, to embed the nanometer-sized silicon within an insulating host will enhance the quantum confinement effect, which spreads the band gap of silicon for photoluminescence emission (Brongersma et al., 1998). During the last few years, various methods were proposed to embed nanometersized silicon, such as implantation of silicon into silicon dioxide (Brongersma et al., 1998), Si/SiO<sub>2</sub> superlattice structure (Photopoulos et al., 2000; Benyoucef, & Kuball, 2001), thermal-oxidized nanocrystalline silicon (Jeon et al., 2005). At the same time, these techniques suffer from complicated and high temperature process, thus unsuitable for developing low cost array or flexible optoelectronic nanocrystalline silicon devices.

Nanocrystalline silicon has been synthesized by several techniques such as microwave or laser induced decomposition of silane (SiH<sub>4</sub>) like precursors (Takagi et al. 1990; Ehbrecht et al., 1995), pulsed-laser deposition of silicon (Werwa et al., 1994), low pressure chemical vapor deposition (Nakajima et al., 1996), electrochemical etching of silicon wafers (Canham, 1990; Belomoin et al., 2002), ion implantation of Si<sup>+</sup> (Iwayama et al., 1994), cosputtering of silicon and silicon dioxide (Zhang et al., 1995), and plasma-enhanced chemical vapor deposition (Inokuma et al., 1998).

On the other hand, for the visible luminescence properties of nanocrystalline silicon, control of the size distribution and surface condition of nanocrystalline silicon with reproducibility is critical to the sensitive light emitting properties. The photoluminescence is highly dependent on the discrete size of silicon nanocrystals and also changes with different surface passivation. For the decomposition, pulsed-laser deposition, and low pressure chemical vapor deposition methods, both surface passivation and deposition of nanocrystalline silicon thin films without agglomeration need further investigations. For the electrochemical etching method, preparation condition dependence and degradation of the photoluminescence are major concerns. For the ion implantation method, multiple implantation at different energies is required to create a thick layer of nanocrystalline silicon. Compared with other fabrication methods, plasma-enhanced chemical vapor deposition has been extensively utilized in the industry and is compatible with ultra-large scale integration technology. Nanocrystalline silicon thin films formed by plasma-enhanced chemical vapor deposition have shown strong and stable photoluminescence, robust structure, and good surface passivation. The characteristics of nanocrystalline silicon films deposited by plasma-enhanced chemical vapor deposition can be finely tuned through silicon concentration in the films as well as post-deposition annealing and oxidation. Study of the influence of the different deposition parameters on the growth of the material is therefore important both for newer device applications and also for understanding the basic physics of the growth process of thin films. Several deposition parameters, such as plasma energy and density, substrate temperature, rf power, gas flow rate, deposition pressure and dilution of the source gas (silane) with other gases (argon, hydrogen, or helium) will strongly influence the structure and properties of the grown nanocrystalline silicon thin films. The effect of Argon dilution on the structure of hydrogenated amorphous and microcrystalline silicon films deposited by rf glow discharge decomposition of silane has been demonstrated (Das et al. 1996; Chaudhuri & Das, 1995; Wang et al., 2003). A detailed experimental study has been reported on the effect of the dilution of silane with hydrogen on optical properties of hydrogenated amorphous silicon prepared by plasma deposition as function of the gas-volume ratio and the substrate temperature (Yamaguchi & Moigaki, 1999). However, most features of the hydrogenated amorphous silicon network structure are defined at the time of growth and therefore the optical and electric properties depend on the details of the deposition process. In the present work, we report the growth and characterization of hydrogenated nanostructured silicon thin films deposited by plasma-enhanced chemical vapor deposition technique. The large numbers of atomic hydrogen are necessary for passivation of dangling bonds and reconstruction of Si-Si bonds to improve film quality. Also, it has been known that the deposition of nanocrystalline silicon is due to the selective etching activity of hydrogen atoms towards the amorphous phase with respect to the crystalline structure. Thus, the role of hydrogen is to promote the nucleation and the crystallization of hydrogenated amorphous silicon at low temperature with desired grain size (Solomon et al., 1993). The use of SiF<sub>4</sub> has also been successfully employed to obtain more orderly materials since fluorine atoms, produced in SiF<sub>4</sub> plasma decomposition, are effective etchant species (Mohri et al., 1991). These facts were considered in choosing the feed gases. In the study of Lim et al. (Lim et al., 1996), the deposition temperature was decreased until 220 °C. Thus, the grain size decreased until 20 nm. In the present contribution, the deposition temperature was further decreased up to 60 °C with high H<sub>2</sub> dilution to further decrease the grain size. The aim of this work is to get more insight into the effect of deposition temperature, air exposure and hydrogen flow rate ([H<sub>2</sub>]) on the optical and structural properties of hydrogenated nanostructured silicon thin films, and also the possibility to enhance the optical properties of hydrogenated nanostructured silicon

thin film. To our knowledge, the effect of air exposure on the optical and structural properties of hydrogenated nanostructured silicon thin films is not studied before.

## 2. Experimental method

The hydrogenated nanostructured silicon films were deposited by radio frequency (rf) glow-discharge (at 13.56 MHz) decomposition of a  $\text{SiH}_4/\text{SiF}_4$  (+He)/ $\text{H}_2$  mixtures in a hot-wall type fused quartz reactor with 50 mm in diameter, employing the inductive coupling of rf power, which were inserted into an electric furnace. The substrates were loaded horizontally on a quartz boat with its surface parallel to the axis of the reactor. The remarkable feature of this deposition system is that the samples are exposed to the plasma (the growing surface is bombarded with ions). When plasma-enhanced chemical vapor deposition hydrogenated nanostructured silicon films were deposited using this deposition system, it has been reported that the resultant hydrogenated nanostructured silicon films have the following two essential effects as the rf power is increased: An enhancement in the degree of preferential orientation of grains in the films and an improvement in the flatness on the film surface (Hasegawa et al. 1990). Such results should be caused by an effect of ion bombardments on the film surface during growth (Hasegawa et al. 1990), and such an effect may also act to lower deposition temperature for preparing high-quality hydrogenated nanostructured silicon films as well as an effect due to fluorine chemistry. The deposition pressure was adjusted by throttling the cross section in the inlet of the pump, and was measured using an absolute pressure meter. The details of the plasma-enhanced chemical vapor deposition system used have been described elsewhere (Hasegawa et al. 1983). Just prior to the deposition of hydrogenated nanostructured silicon films, the substrates were sequentially cleaned by rinsing them for 30 min in acetone and then in ethyl alcohol using an ultrasonic syringe. The samples were more cleaned by exposing them to the  $\text{N}_2$  and then  $\text{H}_2$  plasma at 90 W for 20 min. Then hydrogenated nanostructured silicon films were deposited at the different deposition temperature with the dynamic pressure of 0.3 Torr for every deposition. The rf power supply of 20 W was used. The gas flow rates were  $[\text{SiH}_4] = 0.6$  sccm,  $[\text{SiF}_4] = 0.38$  sccm, which was diluted with 95 % helium (He: 95 %,  $\text{SiF}_4$ : 5 %), and  $[\text{H}_2] = 20, 30$  and 46 sccm. The deposition temperature was varied from 60 °C to 300 °C.

The structural properties of the nanocrystalline silicon films were investigated by means of X-ray diffraction (SHIMADZU XD-D1) employing a diffractometer with the slit width of 0.1 mm, set at the front of the detector. The average grain size,  $\langle\delta\rangle$ , in the depth direction was estimated from the half-width value of the X-ray spectrum by means of the Scherrer formula (Cohen, 1978).

The crystallinity was also characterized by Raman scattering measurements. The Raman spectra consisted of a narrow line at 520  $\text{cm}^{-1}$  due to a crystalline phase and a broad line around 480  $\text{cm}^{-1}$  due to an amorphous phase. Since the third component between 480 and 520  $\text{cm}^{-1}$  due to very small crystallites was relatively weak. Further, the surface morphology of the films was investigated by means of atomic force microscopy (Park scientific instruments, AUTOPROBE GP/M5).

Photoluminescence was analyzed using a Jobin Yvon RAMANOR HG 2S spectrometer coupled with a cold photo-multiplier tube (Hamamatsu Photonics R649S). The 488 nm Ar-ion laser with power ranging from 30 to 50 mW was used as the photoluminescence excitation source. The infrared vibration spectra, using a Fourier-transform spectrometer (JASCO FT/IR-610), were measured at a normal light incident and under vacuum, using a bare silicon wafer as reference in the range of 400 – 4000  $\text{cm}^{-1}$ . The optical transmission spectra were measured using an UV/VIS/NIR spectrophotometer (JASCO V-570).

### 3. Film structure and morphology

In order to further improve properties of hydrogenated nanostructured silicon thin films and performances of related devices, it is necessary to understand microstructure features of the films in detail. As a powerful technique, Raman spectroscopy has been extensively adopted to investigate the low-dimension structure materials because it is convenient and inexpensive and does not damage samples (Wei et al., 2007). Fig. 1 shows a typical Raman spectra from hydrogenated nanostructured silicon thin films deposited with different deposition temperature, which can be identified as two regions corresponding to two kinds of phonon modes, i.e., a transverse optical ( $TO_1$ ) branch with a peak at  $480\text{ cm}^{-1}$  from the amorphous silicon contribution and another transverse optical ( $TO_2$ ) mode at around  $520\text{ cm}^{-1}$  from the contribution of silicon nanocrystals. As revealed in this diagram, the films with deposition temperature higher than  $60\text{ }^\circ\text{C}$  exhibit a narrow peak at around  $520\text{ cm}^{-1}$ , which is due to the crystalline phase. In addition, for the film deposited at a low deposition temperature of  $60\text{ }^\circ\text{C}$  exhibits the broad peak at  $480\text{ cm}^{-1}$  due to an amorphous phase. Thus, no crystallization was observed at deposition temperature =  $60\text{ }^\circ\text{C}$ , which may be caused by a decrease in the rate of the surface migration of the adsorbates caused by elimination of hydrogen atoms on the growing surface of the film. In addition, the peak position of  $TO_2$  increases with increasing the deposition temperature. Such Raman peak shifts would be related to a change in the stress of the films. In other words, the redshift of  $TO_2$  mode peak should be considered as the total contribution from tensile strain effect of silicon nanocrystals embedded in hydrogenated nanostructured silicon thin films. Where, a positive Raman-peak shift can be interpreted as indicating an increase in the compressive stress or a decrease in the tensile stress.

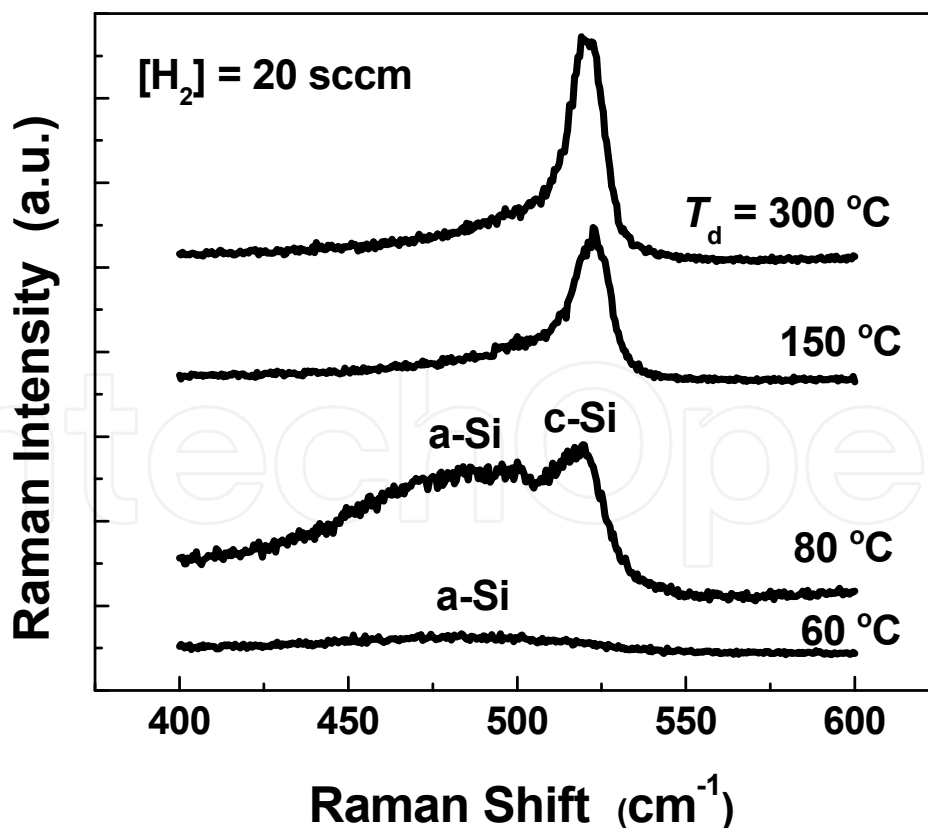


Fig. 1. Raman spectra for hydrogenated nanostructured silicon thin films deposited at different temperature,  $T_d$

Fig. 2 shows the (110) average grain size obtained from the  $\langle 110 \rangle$  x-ray diffraction spectra, for as deposited films (closed triangles) and exposed to air for two months films (closed circles), respectively, as a function of deposition temperature. As shown in Fig. 2, with decreasing deposition temperature the average grain size,  $\langle \delta \rangle$ , decreases. We can also see the effect of air exposure. When the time of air exposure increases, as shown in this diagram, it is found that the  $\langle \delta \rangle$  values decrease. It is clear that the positive shift of Raman-peak with deposition temperature is in good agreement with the increase of grain size with deposition temperature. In other words, according to a phonon confinement effect, the upshift of phonon peak is due to the increase of the hydrogenated nanostructured silicon grains size.

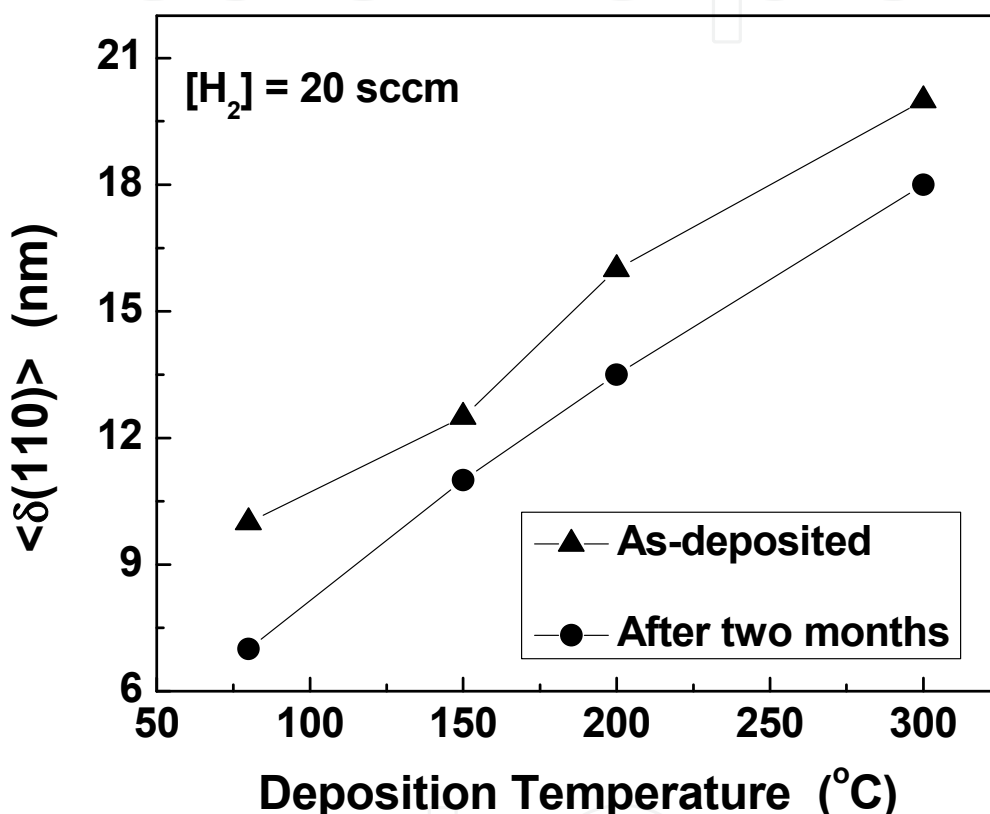


Fig. 2. Average grain size,  $\langle \delta(110) \rangle$  obtained from  $\langle 110 \rangle$  X-ray diffraction spectra as a function of deposition temperature, for as deposited films (closed triangles) and exposed films to air for two months (closed circles)

For growth of crystallites in hydrogenated nanostructured silicon thin films, SiH-related adsorbates responsible for the film growth must move on the growing surface until the adsorbates find the lattice sites for forming the crystallites with a given texture. According to the model proposed by Matsuda (Matsuda, 1983), high deposition temperature conditions should decrease the surface migration rate for eliminating the crystalline phases from films. However, as seen in Fig. 2, small grains grown in the films with deposition temperature higher than  $60^{\circ}\text{C}$ . Furthermore, the density of SiH-related bonds monotonically decreases with deposition temperature, as shown later. These results suggest that an increase in deposition temperature causes an increase in the surface migration rate, in contrast with the model proposed by Matsuda (Matsuda, 1983). Thus,

we can obtain silicon films including nanometer-sized crystallites by decreasing deposition temperature, as seen in Fig. 2, which have attracted increased interest as optoelectronic materials. This is because the decrease in the deposition temperature will suppress the surface migration of the adsorbates as precursors for creating a crystalline phase as stated above.

The surface morphology of the thin films prepared with different deposition temperature (Figs. 3a and 3b) and the time of air exposure (Figs. 3b and 3c) has been measured by atomic force microscopy, as shown in Fig. 3. It can be seen clearly from Fig. 3a that the surface is almost flat corresponds to the amorphous tissue in good agreement with the result from Raman data (Fig. 1). On the other hand, it can be seen from Fig. 3b and 3c that the shape of the grains on the surface is spherical. In addition, the nanocrystallites of the silicon are distributed nearly uniform over the surface and hence suitable for integration in device structure. It is therefore expected that grown thin films could be used as protective coatings in device. The average grain size values estimated from atomic force microscopy data in Fig. 3b are larger than that in Fig. 3c, in good agreement with that calculated from the Scherrer's formula (Fig. 2).

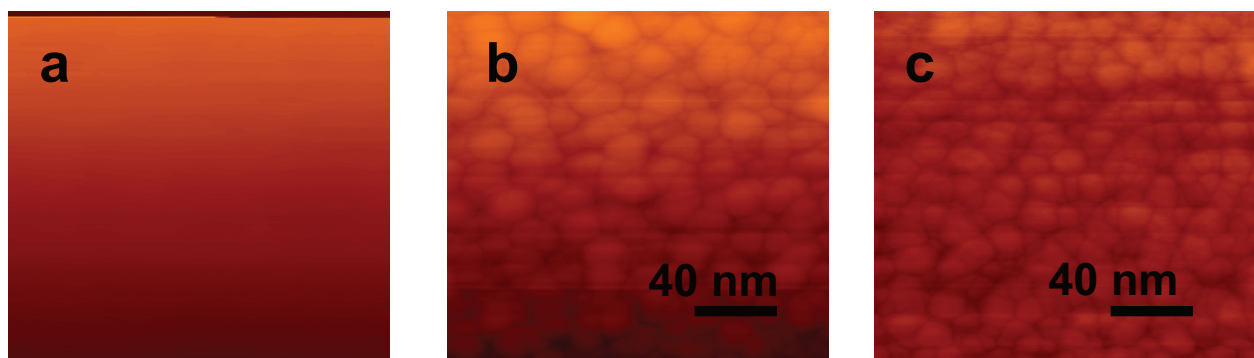


Fig. 3. The atomic force microscopy (AFM) pictures of deposited silicon thin films at  $[H_2] = 20$  sccm. (a) The AFM of sample deposited at deposition temperature ( $T_d$ ) of 60 °C. (b) The AFM of sample deposited at  $T_d$  of 150 °C before air exposure (as-deposited). (c) The AFM of sample deposited at  $T_d$  of 150 °C after two months air exposure

It is well known that when polycrystalline silicon or hydrogenated nanostructured silicon is used as a gate electrode or an interconnection material in integrated circuits, the undesirable oxidation results in a limitation of its conductivity and finally can degrade circuit performance. Furthermore, the grain boundaries in the polycrystalline silicon or hydrogenated nanostructured silicon, which has disordered structures including weak bonds, are expected to oxidize more rapidly than the inside of the grains with stable structure. By using Fourier-transform infrared spectroscopy measurement, we investigated the stability and the oxidation rates of some selected samples with different structures. To investigate the oxidation rates of these films we measured them again after two months. Fig. 4 reports the Fourier-transform infrared transmission spectra of the hydrogenated nanostructured silicon films deposited at different deposition temperature, Fig. 4a for as deposited films and Fig. 4b as the results after air exposure for two months. Firstly, considering the virgin (as deposited) samples (Fig. 4a), the spectra observed at around  $650\text{ cm}^{-1}$  and  $950\text{--}980\text{ cm}^{-1}$  are assigned to the rocking/wagging and bending vibration

modes of  $(\text{Si}_3)\text{-SiH}$  bonds, respectively (Kroll et al., 1996). The stretching mode of Si-F vibration is also located at  $800\text{-}900\text{ cm}^{-1}$ .

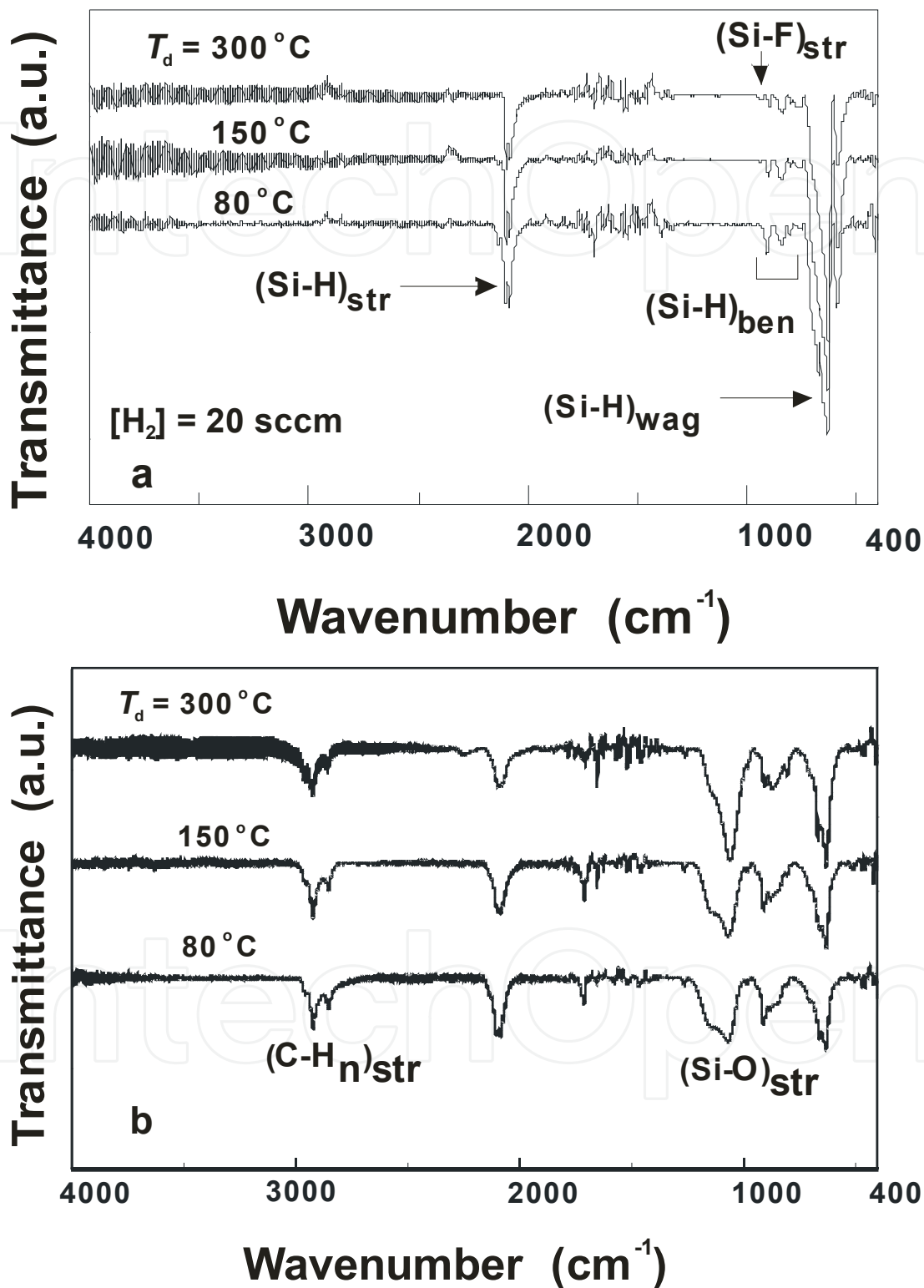


Fig. 4. Infrared transmittance spectra for hydrogenated nanostructured silicon thin films with different deposition temperature ( $T_d$ ) values. (a) As-deposited and (b) After two months air exposure



The peak at  $2100\text{ cm}^{-1}$  is assigned to the dihydride,  $((\text{Si}_2)\text{-SiH}_2)$  (Itoh et al., 2000), chain structure in the grain boundaries, or gathered  $(\text{Si}_3)\text{-SiH}$  bonds on the surface of a large void (Street, 1991), in which silicon dangling bonds are included and makes a porous structure. The intensity of the spectra at around  $2100\text{ cm}^{-1}$  is likely to decrease with increasing deposition temperature. So, the hydrogen content decreases with increasing deposition temperature. The hydrogen atoms in the hydrogenated nanostructured silicon thin films are suggested to reside mostly in the grain boundary region. On the other hand, we can see the films after two months air exposure exhibit a more oxidation (see Fig. 4b). The spectra observed at around  $1100\text{ cm}^{-1}$  and  $2700\text{-}3000\text{ cm}^{-1}$  are assigned to the stretching mode of Si-O-Si vibration and (CH) stretching, respectively (San Andre's et al., 2003). The oxygen absorption peak increases abruptly (see Fig. 4b). The presence of oxygen in the hydrogenated nanostructured silicon thin films is probably due to the oxidation at the grain boundaries, that is why  $\langle\delta\rangle$  values decrease in the films exposed to air for two months, as seen in Fig. 2 (closed circles).

A comparison between the virgin (as deposited) samples, corresponding to Fig. 4a, and those measured after two months, corresponding to 4b, shows a reduction in the  $(\text{Si}_3)\text{-SiH}$ -related peaks at  $2100$  and  $630\text{ cm}^{-1}$  and leads to an increase in the Si-O-Si vibration at  $1064\text{ cm}^{-1}$  after two months. For interpreting an increase in Si-O-Si peaks for samples measured after air exposure, we could consider the following assumption: The oxygen atoms can be replaced with hydrogen atoms on the surface of void structure in the grain boundaries or those in amorphous-like regions between the grains. Then, we assume that some of the oxygen atoms, supplied from  $\text{O}_2$  in the air, react with the SiH bonds and leaving  $\text{H}_2\text{O}$  or  $\text{H}_2$  behind.

## 4. Optical properties

### 4.1 Photoluminescence

The photoluminescence spectra are plotted in Fig. 5, 5a as deposited and 5b exposed to air for two months, respectively, as a function of photon energy for various films. They exhibit two separated photoluminescence bands: One is a relatively strong photoluminescence band with peak energy at around  $1.75\text{-}1.78\text{ eV}$  ( $708\text{-}696\text{ nm}$ ) and the other is a weak band at around  $2.1\text{-}2.3\text{ eV}$  ( $590\text{-}539\text{ nm}$ ). Both of these peaks are at energies above the band gap energy for crystalline silicon ( $1.12\text{ eV}$  at room temperature) which has an indirect band gap and is also not expected to luminescence in the visible range. In addition, Fig. 5 shows the dependence of photoluminescence spectrum on the deposition temperature and the time of air exposure. As the deposition temperature decreases and the time of air exposure increases the photoluminescence intensity and photoluminescence peak energy values increase, i.e., photoluminescence improved with air exposure. It is noted that the photoluminescence spectra from this nanocrystalline silicon were very broad, and that as the nanocrystal size was reduced, photoluminescence broadening accompanied photoluminescence blue shift. The width of the observed photoluminescence could be explained by the distributions of sizes in our hydrogenated nanostructured silicon, and therefore of energy gaps. As seen in Figs. 2, 4 and 5, the increase in the photoluminescence intensity and the peak energy with decreasing deposition temperature and increase the time of air exposure is found to correspond well with a decrease in  $\langle\delta\rangle$  (see Fig. 2 and an increase in the intensities of the  $2100\text{-cm}^{-1}$ -infrared-absorption bands (see Fig. 4a and  $1100\text{-cm}^{-1}$ -infrared-absorption bands (see Fig.4b).

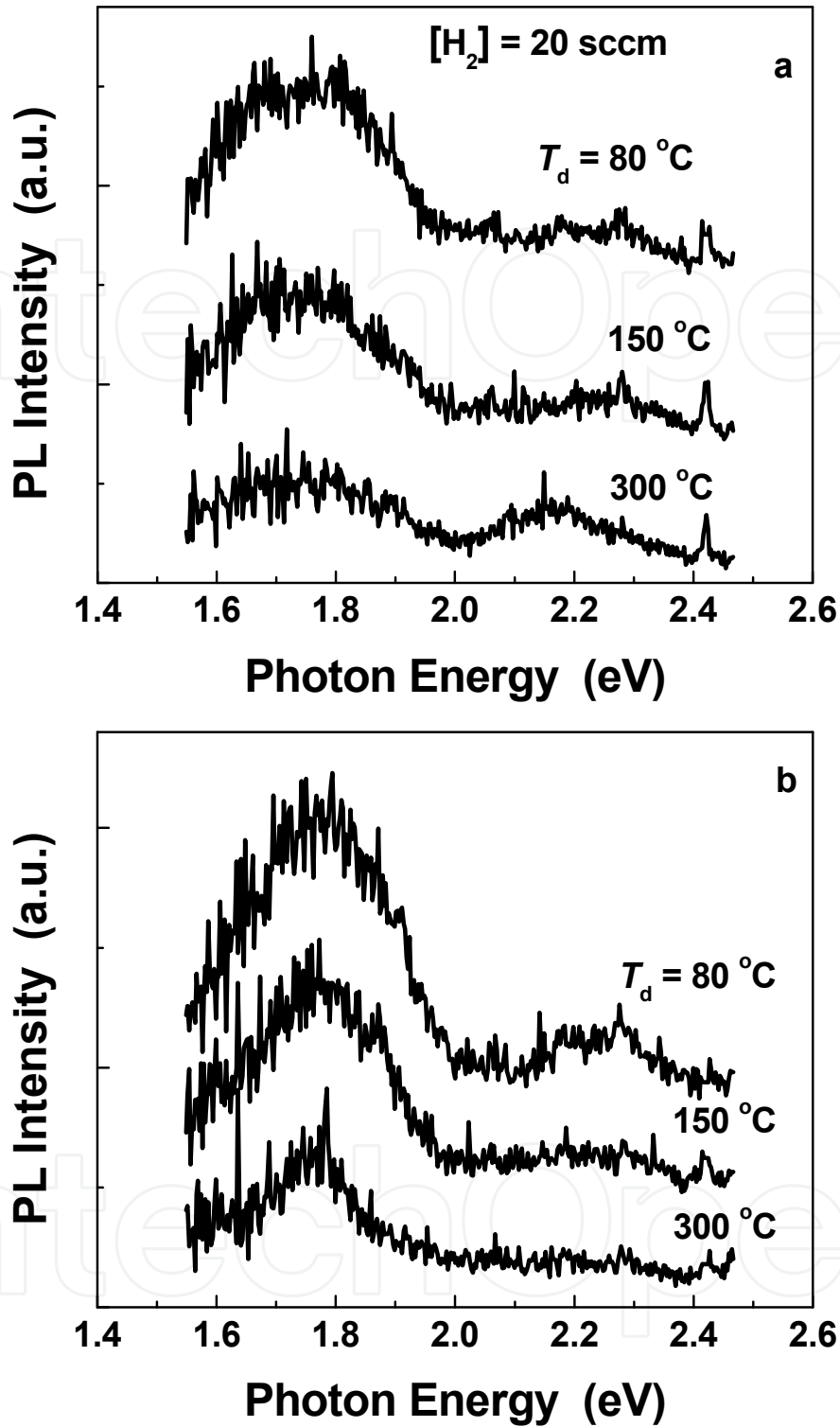


Fig. 5. Photoluminescence (PL) spectra for hydrogenated nanostructured silicon thin films with different deposition temperature values. (a) As-deposited and (b) After two months air exposure

In addition, no photoluminescence is observed for the film as deposited at  $60\text{ }^\circ\text{C}$ , which was amorphous as seen in Fig. 1. Therefore, it is considered that an amorphous silicon phase is not responsible for the observed luminescence in the present work. The origin of the first

peak (1.75-1.78 eV) may be ascribed to nanometersized grains, that is, the photoluminescence peak energy value for this band increases with a decrease in the  $\langle\delta\rangle$  value (Fig. 1b). And the origin of second peak (2.1-2.3 eV) may be due to defect related oxygen (Fig. 2). On the other hand, it has been suggested that the exciton localization at the Si/SiO<sub>2</sub> interface is important in determining the photoluminescence process for both 1.65 and 2.1 eV bands (Kanemitsu et al., 2000). In addition, the photoluminescence bands for H-passivated nanocrystalline silicon films show red shifts after passivation, in contrast to the cause of O-passivated films that show blue shifts after passivation (Dinh et al., 1996) in good agreement with the present work. Moreover, It has been widely established that the origins of photoluminescence from amorphous silicon dioxide are oxygen-vacancies (E' center, normally denoted by  $\text{O}=\text{Si}-\text{Si}=\text{O}$ ) (Kenyon et al., 1994; Zhu et al., 1996) and nonbridging oxygen hole (NBOH) center, denoted by  $\equiv\text{Si}-\text{O}$ ) (Munekuni et al., 1990; Nishikawa et al., 1996). Photoluminescence from E' center peaks at 2.0-2.2 eV and from nonbridging oxygen hole peaks at 1.9 eV, covering the range from 1.55-2.25 eV. Oxygen-vacancies in fact joint two  $\text{Si}^{3+}$ , and nonbridging oxygen hole,  $\text{Si}^{4+}$  with a dangling bond at one oxygen atom. So the intensity of photoluminescence from E' centers should be in proportion to the amount of  $\text{Si}^{3+}$ , and the photoluminescence intensity from nonbridging oxygen hole should be in proportion to the amount of defect  $\text{Si}^{4+}$ , which is in fact  $\text{Si}^{4+}$  containing a dangling bond, and will diminish if this dangling bond combines with other silicon atom (Fang et al., 2007).

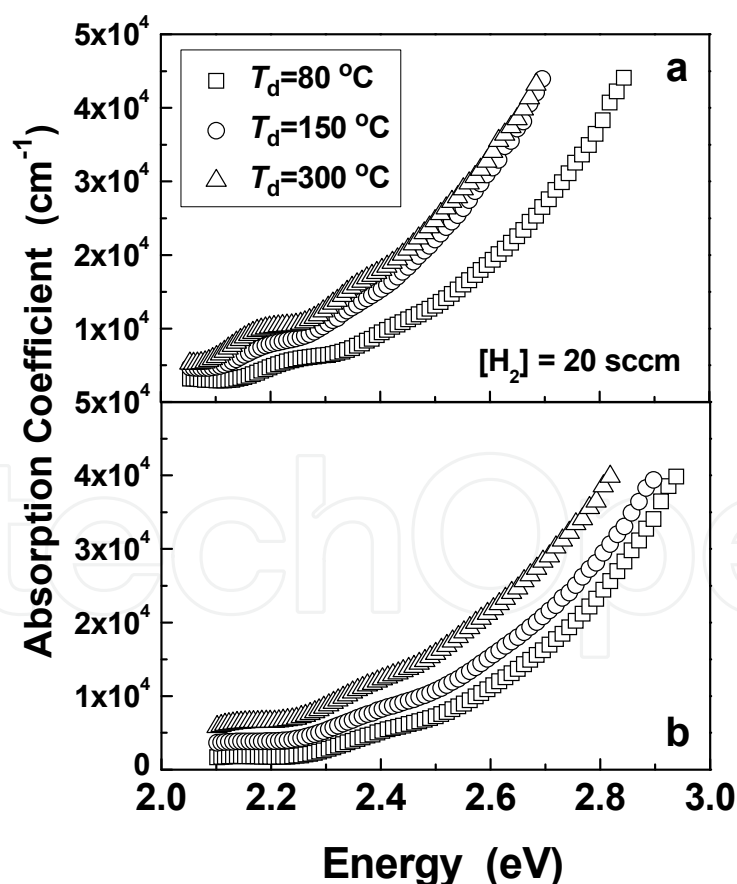


Fig. 6. Absorption coefficient as a function of photon energy for hydrogenated nanostructured silicon thin films deposited at various deposition temperature ( $T_d$ ). (a) As-deposited and (b) After two months air exposure

#### 4.2 Absorption spectroscopy

Fig. 6 shows the absorption coefficient of the hydrogenated nanostructured silicon thin films deposited at various deposition temperatures, as a function of photon energy. As seen in Fig. 6, the curves are shifted to higher energy as deposition temperature decreases and after two months air exposure, which implies that for a given photon energy, the films became increasingly transparent with decreased deposition temperature and after two months air exposure. Fig. 7 illustrates the values of  $(ahv)^{1/2}$  versus photon energy for hydrogenated nanostructured silicon thin films deposited at different deposition temperature. From these curves, the optical band gaps can be obtained from the Tauc equation. The optical band gap decreases as the deposition temperature increases. This expected behavior could be explained by the change of size and the number of the formed particles with the variation of deposition temperature. In addition, the present materials have a wide optical band gap. Thus, the increase in optical band gap (Fig. 7) corresponds with a decrease in the grain size as shown in Fig. 2. Other theoretical and experimental researches attribute this phenomenon at the quantum confinement effect, e.g. the gap energy is conditioned on the size of the nanocrystals.

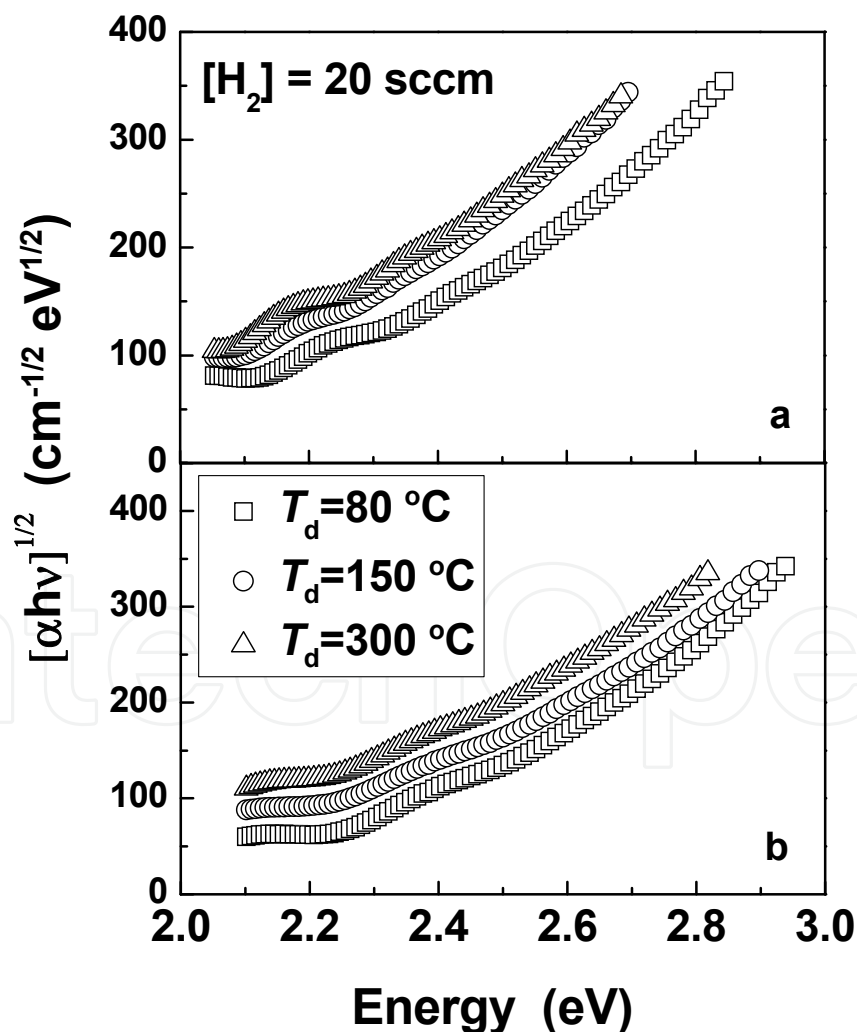


Fig. 7. Curves of  $(ahv)^{1/2}$  vs. photon energy for hydrogenated nanostructured silicon thin films (a) As-deposited and (b) After two months air exposure

#### 4.3 Band gap based on simple theory

Fig. 8 shows (a) the optical band gap,  $E_g^{opt}$ , and (b) photoluminescence peak energy,  $E_{PL}$ , of the 1.7–1.75-eV band observed for hydrogenated nanostructured silicon films deposited at different  $[H_2]$ , as a function of deposition temperature. The  $E_g^{opt}$  values were determined by drawing the Tauc plots,  $(ah\nu)^{1/2}$  versus  $(h\nu - E_g^{opt})$ , using the optical absorption coefficient,  $a$ , observed at photon energy of  $h\nu$ . As revealed in Fig. 8, an increase in  $E_{PL}$  corresponds well with an increase in  $E_g^{opt}$  with varying deposition temperature or  $[H_2]$ , though the rates in the increase of  $E_{PL}$  is considerably smaller than that of  $E_g^{opt}$ . This result suggest that the radiative recombination between excited electron and hole pair, may be caused by states other than those at both the band edges.

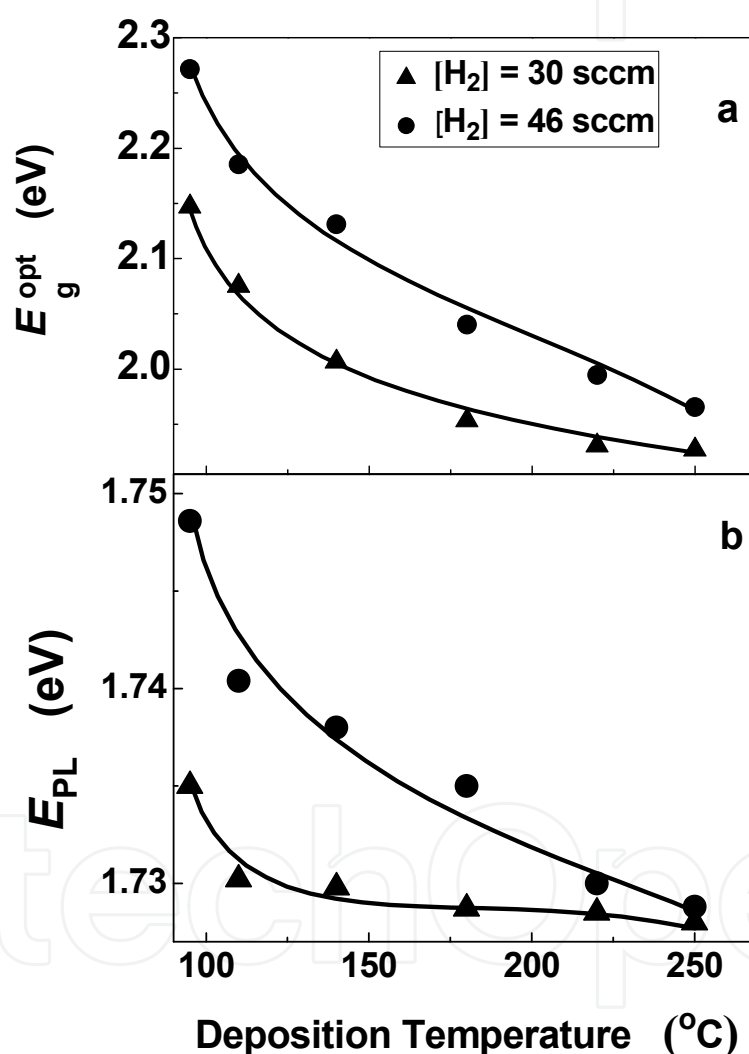


Fig. 8. (a) Optical band gap,  $E_g^{opt}$ , and (b) the peak energy,  $E_{PL}$ , of the 1.7–1.75-eV photoluminescence band observed for hydrogenated nanostructured silicon films deposited at different  $[H_2]$ , as a function of deposition temperature.

In this section, we will discuss the band gap estimated using the shifts of the Raman spectra that will reflect the characteristics of the whole grains with different size as well as the photoluminescence and the optical absorption measurements. As shown in Fig. 1, the Raman peak arising from crystalline phases shifts toward a low frequency side with

decreasing deposition temperature. Supposing that the peak shift is due only to the confinement of optical phonons in spherical nanocrystals, we can estimate the crystallite size in diameter,  $D_R$ , as (Edelberg et al., 1997):

$$D_R = 2\pi(B / \Delta\nu)^{1/2} \quad (1)$$

where  $B$  is  $2.24 \text{ cm}^{-1} \text{ nm}^2$ , and  $\Delta\nu$  the frequency shift in unit of  $\text{cm}^{-1}$ , which was defined as the difference between the observed peak-frequency value and  $522 \text{ cm}^{-1}$ . The latter value was observed for single crystal silicon. Fig. 9 shows a relationship between  $\langle\delta(111)\rangle$  and  $\langle\delta(110)\rangle$ , and  $D_R$ .

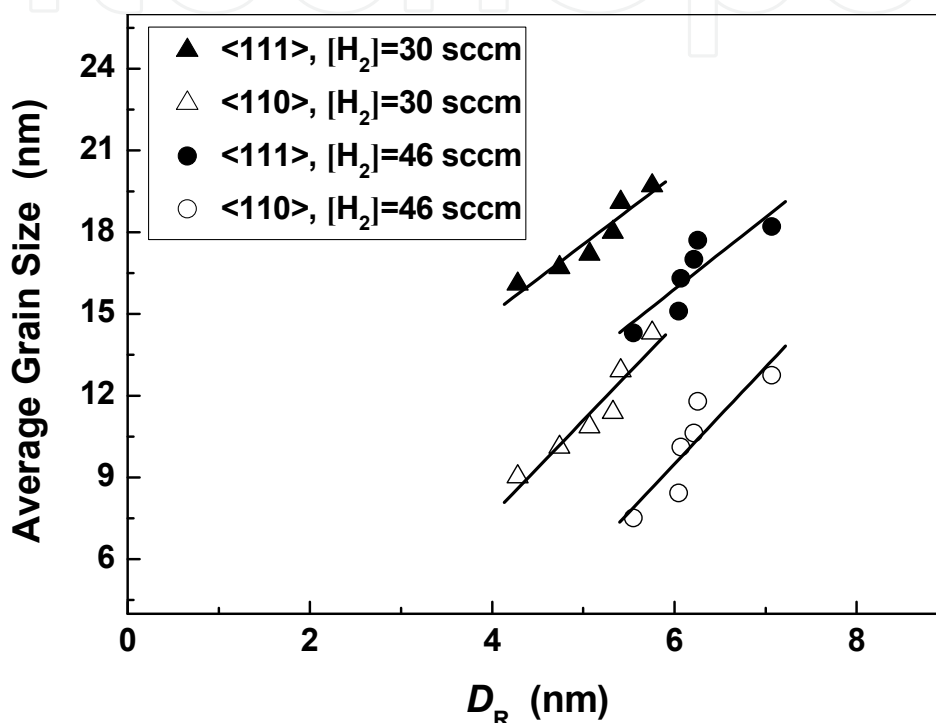


Fig. 9. Relationship between the average grain size,  $\langle\delta(111)\rangle$  and  $\langle\delta(110)\rangle$ , as a function of the diameter of grains,  $D_R$ , calculated using equation (1). The solid lines were drawn, using a method of the least square

When we compared the results obtained under a given crystal direction and a given  $[H_2]$ , we can find a close correlation between the  $\langle\delta\rangle$  and  $D_R$  values. However, it is found that the absolute values of  $\langle\delta\rangle$  observed are considerably larger than  $D_R$  values and the rate in the increase of  $\langle\delta\rangle$  are faster than that of  $D_R$ . Furthermore, based on the results shown in Fig. 9, we find a relationship of  $\langle\delta\rangle = 3.69 D_R - 7.28 \text{ (nm)}$  for the films with  $[H_2] = 30 \text{ sccm}$  and of  $\langle\delta\rangle = 3.56 D_R - 11.89$  for the films with  $[H_2] = 46 \text{ sccm}$ , in the measurements under a direction of the  $\langle 110 \rangle$  axis that is the dominant texture in the films. On the other hand, for the  $\langle 111 \rangle$  texture, we find a relationship of  $\langle\delta\rangle = 2.61 D_R + 4.48$  for  $[H_2] = 30 \text{ sccm}$  and  $\langle\delta\rangle = 2.64 D_R + 0.05$  for  $[H_2] = 46 \text{ sccm}$ . These formulas were obtained by fitting the values of  $\langle\delta\rangle$  vs.  $D_R$  to a linear relationship, using a method of the least square. As seen in these results, the linear relationships of  $\langle\delta\rangle$  as a function of  $D_R$  appear to be characterized by the crystal axis of grains, that is, the slope ( $3.63 \pm 0.07$ ) for the  $\langle 110 \rangle$  texture is steeper than that ( $2.63 \pm 0.02$ ) for the  $\langle 111 \rangle$  texture.

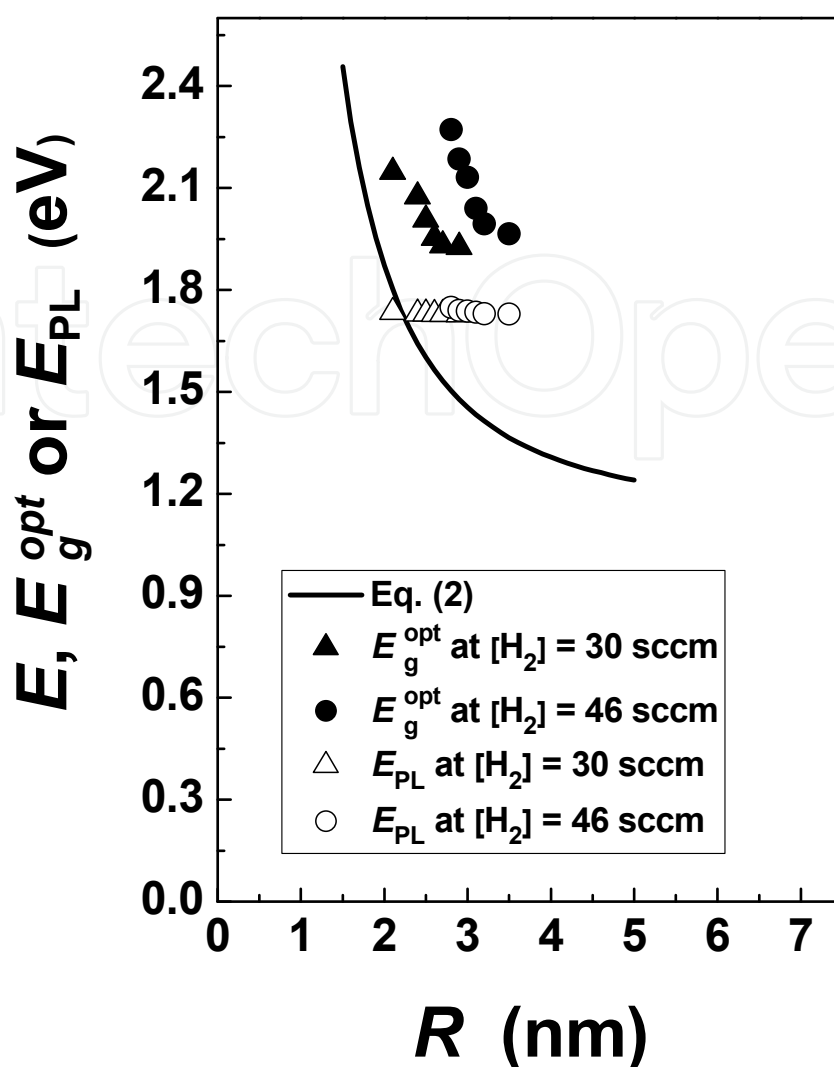


Fig. 10. Lowest excitation energy,  $E$ , as a function of  $R$  (a solid curve), obtained based on equation 2. In this diagram, the experimental values of  $E_g^{opt}$  values (closed symbols) and  $E_{PL}$  (open symbols) values, which were shown in Figs. 8a and 8b, respectively, are also shown for comparison, as a function of  $R(=D_R/2)$  through the  $D_R$  values obtained using the experimental  $\Delta v$  values along with equation 2

Using the values of  $D_R$  for the individual samples, we can evaluate the lowest excitation energy,  $E$ , under a simple confinement theory for electron and hole (Efros et al., 1982; Kayanuma, 1988; Edelberg et al., 1997) as follows:

$$E = E_g + 2\pi^2\hbar^2 / m_r D_R^2 - 3.572e^2 / \epsilon_r D_R + 0.284E_{Ry} \quad (2)$$

where  $E_g$  is the energy gap of crystalline silicon (1.12 eV at room temperature),  $R(=D_R/2)$  is the radius of crystals,  $m_r$  is the reduced effective mass of an electron-hole pair,  $\epsilon_r$  is the dielectric constant, and  $E_{Ry}$  is the Rydberg energy for the bulk semiconductor. The value of  $E$  correspond to the band gap of the films. In the later two terms,  $3.572e^2/\epsilon_r D_R$  corresponds to the coulomb term and  $0.284E_{Ry}$  gives the spatial correlation energy. The later two terms are minor corrections, so we neglected them in the calculation used in this work, because the contribution of these two terms to the total energy will be less than 5% (Edelberg et al., 1997).

Fig. 10 shows the  $E$  values (a solid curve) obtained based on equation 2, as a function of  $R$ . In Fig. 10, the experimental values of  $E_g^{opt}$  (closed symbols) and  $E_{PL}$  (open symbols) shown in Figs. 9a and 9b, respectively, are also shown for comparison, as a function of  $R$  through the values of  $D_R$  obtained using the experimental  $\Delta v$  values along with equation 1.

As shown in Fig. 10, we can find a qualitative agreement between the observed  $E_g^{opt}$  values (closed triangles and closed circles) and a solid curve calculated using equation 2, though the former values are considerably larger than the latter. Furukawa and Miyasato (Furukawa & Miyasato, 1988) have found also similar discrepancy between the theoretical and experimental results, and interpreted the discrepancy in terms of a difference in the surface shape of grains as boundary conditions in both the theoretical and experimental process. On the other hand, the change of  $E_{PL}$  as a function of  $R$  is considerably smaller than those of  $E$  and  $E_g^{opt}$  though the trend of the changes for  $E_{PL}$  agreed with that for  $E_g^{opt}$ . This result indicates that the photoluminescence process of the 1.7–1.75-eV band can not be connected with the transition between both the band edges, related to formation of nanocrystals.

## 5. Conclusion

Hydrogenated nanostructured silicon thin films were deposited by plasma-enhanced chemical vapor deposition. The luminescent characteristics of nc-Si and oxidized Hydrogenated nanostructured silicon thin films were studied in detail by means of the photoluminescence, optical absorption, X-ray diffraction, atomic force microscopy and Raman scattering analyses. After oxidation the size of crystallites is reduced thus enhancing the quantum confinement to increase the luminescent intensity. The presence of nanocrystals induces a widening of energy gap. The widening of the optical band gap can be explained by a quantum size effect.

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## 7. References

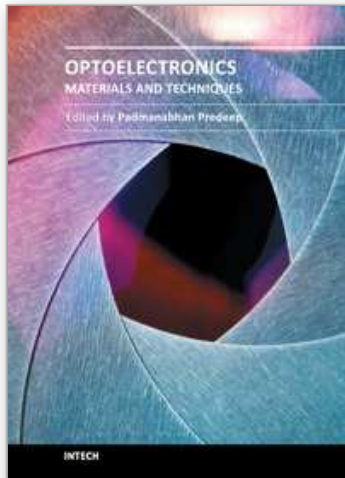
- Belomoin, G.; Therrien, J.; Smith, A.; Rao, S.; Twisten, R.; Chaieb, S.; Nayfeh, M.H.; Wagner, L. & Mitas, L. (2002). Observation of a Magic Discrete Family of Ultrabright Si Nanoparticles, *Applied Physics Letters*, Vol.80, No.5, (February 2002), pp. 841-843. ISSN 0003-6951
- Benyoucef, M.; Kuball, M.; Sun, J. M. ; Zhong, G. Z. & Fan, X. W. (2001). Raman Scattering and Photoluminescence Studies on Si/SiO<sub>2</sub> Superlattices, *Journal of Applied Physics*, Vol.89, No.12, (June 2001), pp. 7903-7907, ISSN 0021-8979
- Brongersma, M.L.; Polman, A.; Min, K.S.; Boer, E.; Tambo, T. & Atwater, H.A. (1998). Tuning the Emission Wavelength of Si nanocrystals in SiO<sub>2</sub> by Oxidation, *Applied Physics Letters*, Vol.72, No.20 (May 1998), pp. 2577-2579, ISSN 0003-6951
- Canham, L.T. (1990). Silicon Quantum Wire Array Fabrication by Electrochemical and Chemical Dissolution of Wafers, *Applied Physics Letters*, Vol.57, No.10, (September 1990), pp.1046-1048, ISSN 0003-6951



- Chaudhuri, P. & Das, U.K. (1995). Control of Microstructure and Optoelectronic Properties of Si:H Films by Argon Dilution in Plasma-Enhanced Chemical Vapor Deposition from Silane, *Japanese Journal of Applied Physics*, Vol.34, No.7A, (July 1995), pp. 3467-3473, ISSN 0021-4922
- Cheng, Q.; Xu, S.; Chai, J.W.; Huang, S.Y.; Ren, Y.P.; Long, J.D.; Rutkevych, P.P. & Ostrikov, K. (2008). Influence of Hydrogen Dilution on the Growth of Nanocrystalline Silicon Carbide Films by Low-frequency Inductively Coupled Plasma Chemical Vapor Deposition, *Thin Solid Films*, Vol.516, No.18, (July 2008), pp. 5991-5995, ISSN 0040-6090
- Cohen, M. (Ed.). (1978). *Elements of X-ray Diffraction*, Addison-Wesley, ISBN 0201011743, Massachusetts
- Das, U. K.; Chaudhuri, P. & Kshirsagar, S. T. (1996). Effect of Argon Dilution on the Structure of Microcrystalline Silicon Deposited from Silane, *Journal of Applied Physics*, Vol.80, No.9, (November 1996), pp. 5389-5397, ISSN 0021-8979
- Dinh, L.N.; Chase, L.L.; Baloch, M.; Siekhaus, W. J. & Wooten, F. (1996). Optical Properties of Passivated Si Nanocrystals and SiO<sub>x</sub> Nanostructures, *Physical Review B*, Vol.54, No.7, (August 1996), pp. 5029-5037, ISSN 1098-0121
- Edelberg, E.; Bergh, S.; Naone, R.; Hall, M. & Aydil, E. S. (1997). Luminescence from Plasma Deposited Silicon Films, *Journal of Applied Physics*, Vol. 81, No.5, (March 1997), pp. 2410-2417, ISSN 0021-8979
- Efros, Al.L. & Efros, A.L. (1982). Interband Absorption of Light in a Semiconductor Sphere, *Soviet Physics-Semiconductors*, Vol.16, (1982), pp. 772-775
- Ehbrecht, M.; Ferkel, H.; Huisken, F.; Holz, L.; Polivanov, Y.N.; Smirnov, V.V.; Stelmakh, O.M. & Schmidt, R. (1995). Deposition and Analysis of Silicon Clusters Generated by Laser Induced Gas Phase Reaction, *Journal of Applied Physics*, Vol.78, No.9, (November 1995), pp. 5302-5306, ISSN 0021-8979
- Fang, Y.C.; Zhang, Z. J. & Lu, M. (2007). Room Temperature Photoluminescence Mechanism of SiO<sub>x</sub> Film after Annealing at Different Temperatures, *Journal of Luminescence*, Vol.126, No.1, (September 2007), pp. 145-148, ISSN 0022-2313
- Funde, A.M.; Bakr, N.A.; Kamble, D.K.; Hawaldar, R.R.; Amalnerkar, D.P. & Jadkar, S.R. (2008). Influence of Hydrogen Dilution on Structural, Electrical and Optical Properties of Hydrogenated Nanocrystalline Silicon (nc-Si:H) Thin Films Prepared by Plasma Enhanced Chemical Vapour Deposition (PE-CVD), *Solar Energy Materials and Solar Cells*, Vol.92, No.10, (October 2008), pp. 1217-1223, ISSN 0927-0248
- Furukawa, S. & Miyasato, T. (1988). Quantum Size Effects on the Optical Band Gap of Microcrystalline Si:H, *Physical Review B*, Vol.38, No.8, (September 1988), pp. 5726-5729, ISSN 1098-0121
- Hasegawa, S.; Narikawa, S. & Kurata, Y. (1983). ESR and Electrical Properties of P-doped Microcrystalline Si, *Philosophical Magazine B*, Vol. 48, No.5, (November 1983), pp. 431-447, ISSN 1364-2812
- Hasegawa, S.; Yamamoto, S. & Kurata, Y. (1990). Control of Preferential Orientation in Polycrystalline Silicon Films Prepared by Plasma-Enhanced Chemical Vapor Deposition, *Journal of The Electrochemical Society*, Vol.137, No.11, (November 1990), pp. 3666-3674, ISSN 0013-4651
- Inokuma, T.; Wakayama, Y.; Muramoto, T.; Aoki, R.; Kurata, Y. & Hasegawa, S. (1998). Optical Properties of Si Clusters and Si Nanocrystallites in High-temperature

- Annealed SiO<sub>x</sub> Films, *Journal of Applied Physics*, Vol.83, No.4, (February 1998), pp.2228-2234, ISSN 0021-8979
- Itoh, T.; Yamamoto, K.; Ushikoshi, K.; Nonomura, S. & Nitta, S. (2000). Characterization and Role of Hydrogen in nc-Si:H, *Journal of Non-Crystalline Solids*, Vol.266-269, No.1, (May 2000), pp. 201-205, ISSN 0022-3093
- Iwayama, T.S.; Nakao, S. & Saitoh, K. (1994). Visible Photoluminescence in Si<sup>+</sup> Implanted Thermal Oxide Films on Crystalline Si, *Applied Physics Letters*, Vol.65, No.14, (October 1994), pp. 1814-1816, ISSN 0003-6951
- Jeon, K.A.; Kim, J.H.; Kim, G.H.; Lee, S.Y. (2005). Oxidation Effects on the Photoluminescent Properties of Si Nanocrystalline Thin Films, *Optical Materials*, Vol.27, No.5, (February 2005), pp. 988-990, ISSN 0925-3467
- Kanemitsu, Y.; Iiboshi, M. & Kushida, T. (2000). Photoluminescence Spectrum of a-Si/SiO<sub>2</sub> and c-Si/SiO<sub>2</sub> Quantum Wells, *Journal of Luminescence*, Vol.87-89, No., (May 2000), pp. 463-465, ISSN 0022-2313
- Kanicki, J. (Ed.). (1991). *Amorphous & Microcrystalline Semiconductor Devices: Optoelectronic Devices*, Artech House, ISBN 10: 0890064903, Boston
- Kanicki, J. (Ed.). (1992). *Amorphous & Microcrystalline Semiconductor Devices: Materials and Device Physics*, Artech House, ISBN 10: 0890063796, Boston
- Kayanuma, Y. (1988). Quantum-size Effects of Interacting Electrons and Holes in Semiconductor Microcrystals with Spherical Shape, *Physical Review B*, Vol.38, No.14, (November 1988), pp. 9797-9805, ISSN 1098-0121
- Kenyon, A.J.; Trwoga, P.F.; Pitt, C.W. & Rehm, G. (1996). The Origin of Photoluminescence from Thin Films of Silicon Rich Silica, *Journal of Applied Physics*, Vol.79, No.12, (June 1996), pp. 9291-9300, ISSN 0021-8979
- Kroll, U.; Meier, J.; Shah, A.; Mikhailov, S. & Weber, J. (1996). Hydrogen in Amorphous and Microcrystalline Silicon Films Prepared by Hydrogen Dilution, *Journal of Applied Physics*, Vol.80, No.9, (November 1996), pp. 4971-7975, ISSN: 0021-8979
- Lim, H.J.; Ryu, L.B.; Ryu, J.I. & Jang, J. (1996). Structural and Electrical Properties of Low Temperature Polycrystalline Silicon Deposited Using SiF<sub>4</sub>-SiH<sub>4</sub>-H<sub>2</sub>, *Thin Solid Films*, Vol.289, No.1-2, (November 1996) 227-233, ISSN 0040-6090
- Lin, C.Y.; Fang, Y.K; Chen, S.F; Chang, S.H. & Chou, T.H. (2006). Enhancing Photoluminescence of Nanocrystalline Silicon Thin Film with Oxygen Plasma Oxidation, *Materials Science and Engineering: B*, Vol..134, No.1, (September 2006), pp. 99-102, ISSN 0921-5107
- Matsuda, A. (1983). Formation Kinetics and Control of Microcrystallite in  $\mu\text{c-Si:H}$  from Glow Discharge Plasma, *Journal of Non-Crystalline Solids*, Vol.59-60, No.2, (December 1983), pp. 767-774, ISSN0022-3093
- Mohri, M.; Kakinuma, H.; Sakamoto, M. & Sawai, H. (1991). Very-Low-Temperature Preparation of Poly-Si Films by Plasma Chemical Vapor Deposition Using SiF<sub>4</sub>/SiH<sub>4</sub>/H<sub>2</sub> Gases, *Japanese Journal of Applied Physics*, Vol.30, No.5A, (May 1991), pp. L779-L782, ISSN 0021-4922
- Munekuni, S.; Yamanaka, T.; Shimogaichi, Y.; Tohmon, R.; Ohki, Y.; Nagasawa, K. & Hama, Y. (1990). Various Types of Nonbridging Oxygen Hole Center in High Purity Silica Glass, *Journal of Applied Physics*, Vol.68, No.3, (August 1990), pp. 1212-1217, ISSN 0021-8979

- Nakajima, A.; Sugita, Y.; Kawamura, K.; Tomita, H. & Yokoyama, N. (1996). Si Quantum Dot Formation with Low-Pressure Chemical Vapor Deposition, *Japanese Journal of Applied Physics*, Vol.35, No.2B, (February 1996), pp. L189 -L191, ISSN 0021-4922
- Nishikawa, H.; Watanabe, E.; Ito, D.; Sakurai, Y.; Nagasawa, K. & Ohki, Y. (1996). Visible Photoluminescence from Si Clusters in  $\gamma$  Irradiated Amorphous SiO<sub>2</sub>, *Journal of Applied Physics*, Vol.80, No.6, (September 1996), pp. 3513-3517, ISSN 0021-8979
- Photopoulos, P.; Nassiopoulou, A.G. & Kouvatso, D.N. (2000). Photoluminescence from Nanocrystalline Silicon in Si/SiO<sub>2</sub> Superlattices, *Applied Physics Letters*, Vol.76, No.24, (June 2000), pp. 3588-3590, ISSN 0003-6951
- San Andre's, E.; del Prado, A.; Ma'rtel, I.; Gonza'lez-Di'az, G.; Bravo, D.; L'opez, F.J. & Fern'andez, M. (2003). Bonding Configuration and Density of Defects of SiO<sub>x</sub>H<sub>y</sub> Thin Films Deposited by the Electron Cyclotron Resonance Plasma Method, *Journal of Applied Physics*, Vol.94, No.12, (December 2003), pp. 7462-7469, ISSN 0021-8979
- Solomon, I.; Dr'evillon, B.; Shirai, H. & Layadi, N. (1993). Plasma Deposition of Microcrystalline Silicon: the Selective Etching Model, *Journal of Non-Crystalline Solids*, Vol.164-166, No.2, (December 1993), pp. 989-992, ISSN 0022-3093
- Street, R.A. (1991); *Hydrogenated Amorphous Silicon*, Cambridge University, ISBN 0521371562, Cambridge
- Takagi, H.; Ogawa, H.; Yamazaki, Y.; Ishizaki, Y.A. & Nakagiri, T. (1990). Quantum Size Effects on Photoluminescence in Ultrafine Si Particles, *Applied Physics Letters*, Vol.56, No.24, (June 1990), pp. 2379-2380, ISSN 0003-6951
- Wang, Y.H.; Lin, J. & Huan, C.H.A. (2003). Structural and Optical Properties of a-Si:H/nc-Si:H Thin Films Grown from Ar-H<sub>2</sub>-SiH<sub>4</sub> Mixture by Plasma-enhanced Chemical Vapor Deposition, *Materials Science and Engineering: B*, Vol.104, No.1-2, (November 2003), pp. 80-87, ISSN 0921-5107
- Wei, W.; Xu, G.; Wang, J. & Wang, T. (2007). Raman Spectra of Intrinsic and Doped Hydrogenated Nanocrystalline Silicon Films, *Vacuum*, Vol.81, No.5, (January 2007), pp. 656-662, ISSN 0042-207X
- Werwa, E.; Seraphin, A.A.; Chiu, L.A.; Zhou, C. & Kolenbrander, K.D. (1994). Synthesis and Processing of Silicon Nanocrystallites Using a Pulsed Laser Ablation Supersonic Expansion Method, *Applied Physics Letters*, Vol.64, No.14, (April 1994), pp. 1821-1823, ISSN 0003-6951
- Yamaguchi, M. & Moigaki, K. (1999). Effect of Hydrogen Dilution on the Optical Properties of Hydrogenated Amorphous Silicon Prepared by Plasma Deposition, *Philosophical Magazine B*, Vol.79, No.3, (March 1999), pp. 387-405, ISSN 1364-2812
- Zhang, Q.; Bayliss, S.C. & Hutt, D.A. (1995). Blue Photoluminescence and Local Structure of Si Nanostructures Embedded in SiO<sub>2</sub> Matrices, *Applied Physics Letters*, Vol.66, No.15, (April 1995), pp. 1977-1979, ISSN 0003-6951
- Zhu, M.; Han, Y.; Wehrspohn, R.B.; Godet, C.; Etemadi, R. & Ballutaud, D. (1996). The Origin of Visible Photoluminescence from Silicon Oxide Thin Films Prepared by Dual-plasma Chemical Vapor Deposition, *Journal of Applied Physics*, Vol.83, No.10, (May 1998), pp. 5386-5393, ISSN 0021-8979



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